

TFT LCD DISPLAY MODULE

Product Specification

| | | | |
|----------------------|------------------|---------------------|---|
| Customer | Standard | |  |
| Model Number | UReady16600-LVDS | | |
| Ordering Part Number | DMT066YYHLNT0-1A | Non-Touch | |
| | DMT066YYHLNT0-1B | Non-Touch + Bracket | |
| | DMT066YYHLCMI-1A | Touch | |
| | DMT066YYHLCMI-1B | Touch + Bracket | |
| Customer Approval | | Date: | |

| Internal Approvals | | |
|-----------------------|-----------------------|-----------------------|
| Product Mgr | Doc. Control | Electr. Eng. |
| Luo Luo | Filip Kaczorowski | Filip Kaczorowski |
| Date: 06/06/18 | Date: 06/06/18 | Date: 06/06/18 |

Revision Record

| Rev. | Date | Page | Chapt. | Comment | ECR no. |
|------|----------|------|--------|----------------------------------|---------|
| 1.0 | 06/06/18 | -- | -- | Initial Release | |
| 1.1 | 24/10/18 | 6 | 1.3 | Part number correction. | |
| 1.2 | 19/11/18 | 13 | 3.2.2 | I/O Voltage level correction. | |
| 1.3 | 07/08/19 | 21 | 3.4.2 | Added the porch/blanking timings | |
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1.0 General Description

1.1 Introduction

The UReady16600 is a colour active matrix TFT (Thin Film Transistor) LCD (liquid crystal display). This module is composed of a Transmissive type TFT-LCD Panel, driver circuit, back-light unit. The resolution of a 6.6" TFT-LCD contains 1440x240 pixels, and can display up to 16.7M colours. The unit can come in with touch capabilities and back mounting bracket.

1.2 Main Features

1.2.1 TFT

| Item | Contents |
|-----------------------|-------------------------------|
| Screen Size | 6.6" Diagonal |
| Display Format | 1440 x RGB x 240 Dots |
| N° of Colour | 65K/262K/16.7M |
| Overall Dimensions | 178.4 mm (H) x 40.0 mm (V) |
| Active Area | 164.16 mm (H) x 27.36 mm (V) |
| Display Mode | Transmissive / Normally Black |
| Viewing Direction | All round |
| TFT Interface | 6/8Bit LVDS |
| TFT Driver IC | 2*HX8249+HX8678 |
| Backlight Type | LED, White, 32 chips |
| Operating Temperature | -30C ~ +85°C |
| Storage Temperature | -40°C ~ +90°C |
| ROHS | Compliant to 2011/65/EU |

1.2.2 PTC

| Item | Contents |
|---------------------------|-------------------------------------|
| PCT Interface | I2C |
| Touch mode | Five points and Gestures |
| PCT Controller IC | GT911 |
| Module Bonding Technology | Optical bonding between LCM and PCT |

1.3 Available Module Options

The UReady16600 with the LVDS interface can come in four different options to best suit the customer's need. The following table outlines the main differences between each model and more detailed differences will be mentioned in the following document. Datasheets for individual items are also available on request.

| Ordering Number | Touch (PCT) | Mounting Bracket |
|------------------|-------------|------------------|
| DMT066YYHLNT0-1A | No | No |
| DMT066YYHLNT0-1B | No | Yes |
| DMT066YYHLCMI-1A | Yes | No |
| DMT066YYHLCMI-1B | Yes | Yes |

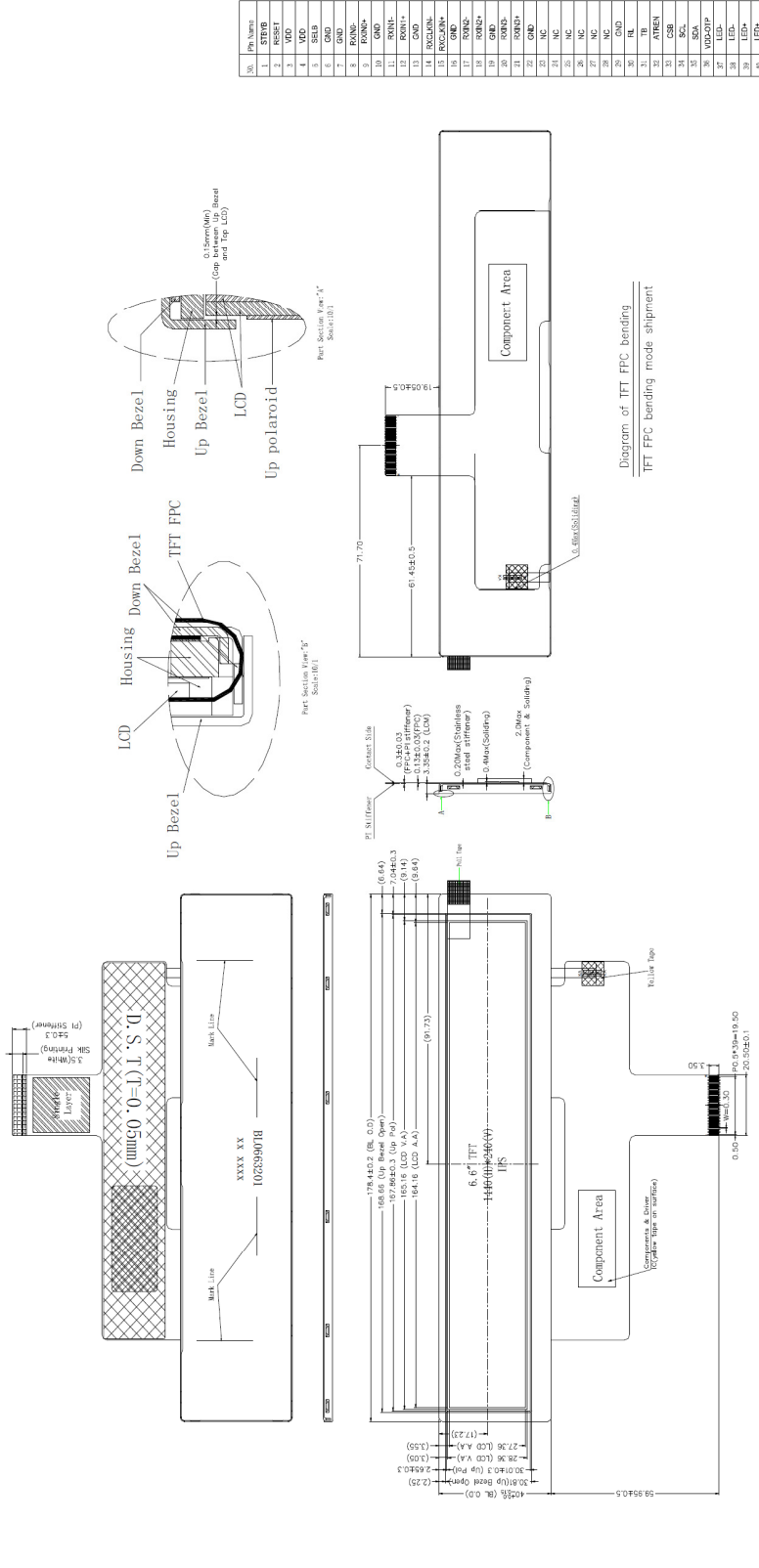
2.0 Mechanical Specification

2.1 Mechanical Characteristics

| Item | Characteristic | Unit |
|---------------------------|---|------|
| Display Format | 1440 x RGB x 240 Dots | Dots |
| Overall Dimensions | - | - |
| DMT066YYHLNTO-1A | 178.4 mm (H) x 40.0 mm (V) x 3.35 mm (D) | mm |
| DMT066YYHLNTO-1B | 178.4 mm (H) x 40.0 mm (V) x 8.75 mm (D) | mm |
| DMT066YYHLCMI-1A | 190.0 mm (H) x 44.0 mm (V) x 5.27 mm (D) | mm |
| DMT066YYHLCMI-1B | 190.0 mm (H) x 44.0 mm (V) x 10.6 mm (D) | mm |
| Active Area | 164.16 mm (H) x 27.36 mm (V) | mm |
| Pixel Pitch | 0.114 (H) x 0.114 (V) | mm |
| Weight | - | - |
| DMT066YYHLNTO-1A | 55 | g |
| DMT066YYHLNTO-1B | 68 | g |
| DMT066YYHLCMI-1A | 85 | g |
| DMT066YYHLCMI-1B | 98 | g |

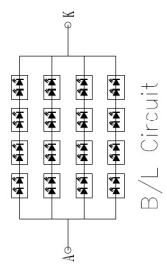
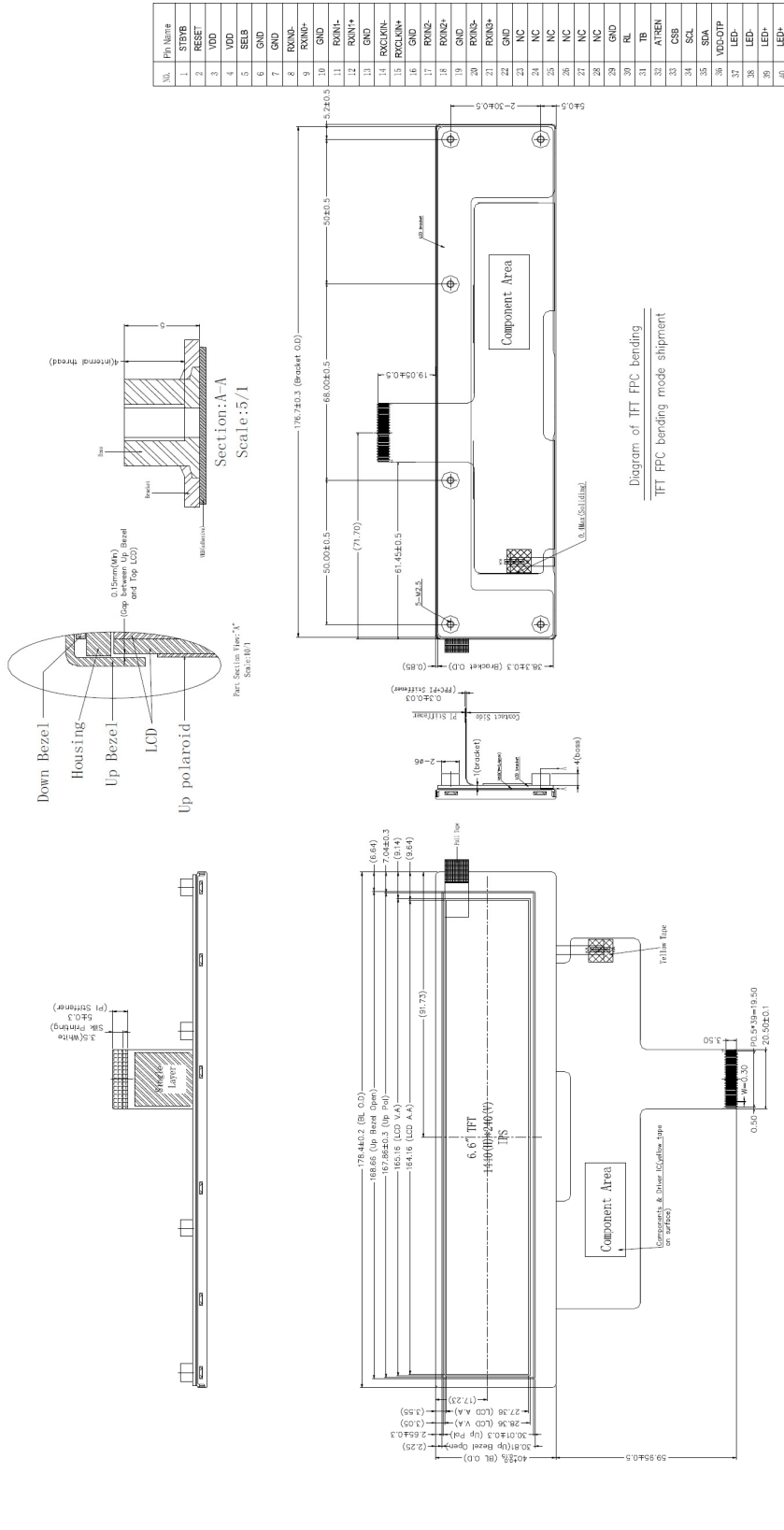
2.2 Mechanical Drawing

- DMT066YYHLNT0-1A



- NOTES:
1. DISPLAY TYPE: 6.6" TFT-LCD, 65/295K/16.7M COLORS
 2. DISPLAY TYPE: 6.6" TFT-LCD, 65/295K/16.7M COLORS
 3. VIEWING DIRECTION: ALL
 4. LCM DRIVER IC: 2*HG6749+HG678 (COG)
 5. TOUCH DRIVER IC: NA
 6. TOUCH INTERFACE: NA
 7. TOUCH AND LCM BONDING TECHNOLOGY: NA
 8. OPERATING TEMP: -30~+85 C
 9. STORAGE TEMP: -40~+150 C
 10. BACK LIGHT: LED WHITE, 16 Dual Chip LED(25.6V/80ma)
 11. Luminance: 800(NIN/80mA), 900cd/m2(TYP/60mA)
 12. Contrast: 1000/1000(A), 1000cd/m2(TYP/80mA)
 13. BARS COMPLIANT.

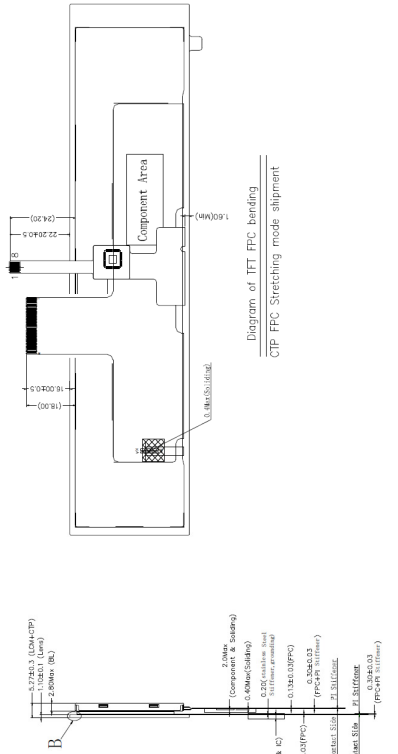
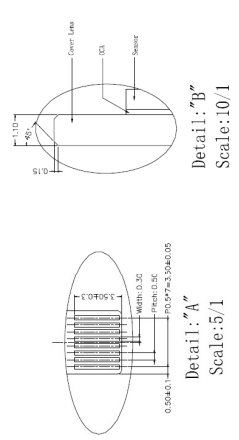
- DMT066YYHLNT0-1B



- NOTES:
1. DISPLAY TYPE: 6.6" TFT-LCD, 65/262K/16.7M COLOURS
 2. DISPLAY MODE: NORMALLY BLACK/IPS
 3. DISPLAY RESOLUTION: 640x480
 4. LCM DRIVER IC: 7189224-HR8E78 (COG)
 5. Touch Driver IC: NA
 6. Touch Interface: NA
 7. Touch and LCD are using Technology: NA
 8. VDD: 1.8V
 9. OPERATING TEMP: -30~+85 C
 10. STORAGE TEMP: -40~+80 C
 11. BACK LIGHT: LED WHITE, 16 Dual Chip LED(25.6V/80mA)
 12. Luminance: 800(UIN/60mA), 900cd/m2(TYP/60mA)
 13. Luminescence: 900(UIN/80mA), 1000cd/m2(TYP/80mA)
 14. R/B/G COMPLIANT.

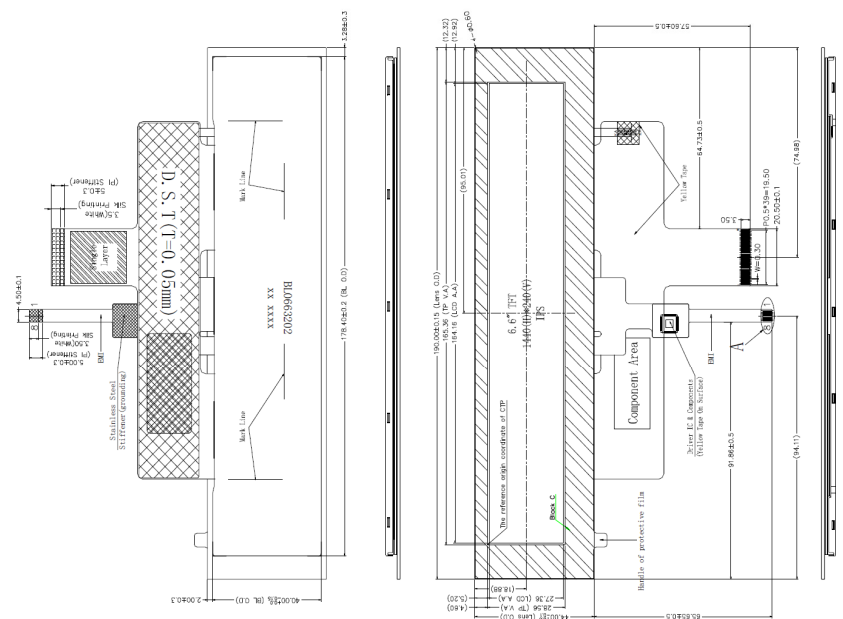
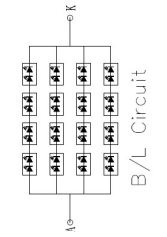
DMT066YYHLDMI-1A

| No. | Pin Name |
|-----|----------|
| 1 | STPB |
| 2 | USFT |
| 3 | VDD |
| 4 | SELB |
| 5 | GND |
| 6 | GND |
| 7 | RXIN+ |
| 8 | RXIN- |
| 9 | RXIN+ |
| 10 | GND |
| 11 | RXIN+ |
| 12 | RXIN+ |
| 13 | GND |
| 14 | RXCLKIN |
| 15 | RXCLKIN+ |
| 16 | GND |
| 17 | RXIN+ |
| 18 | RXIN+ |
| 19 | GND |
| 20 | RXIN+ |
| 21 | RXIN+ |
| 22 | GND |
| 23 | NC |
| 24 | NC |
| 25 | NC |
| 26 | NC |
| 27 | NC |
| 28 | NC |
| 29 | GND |
| 30 | NC |
| 31 | DB |
| 32 | AREN |
| 33 | SB |
| 34 | SCL |
| 35 | SDA |
| 36 | VDDO/P |
| 37 | LED+ |
| 38 | LED- |
| 39 | LED+ |
| 40 | LED+ |



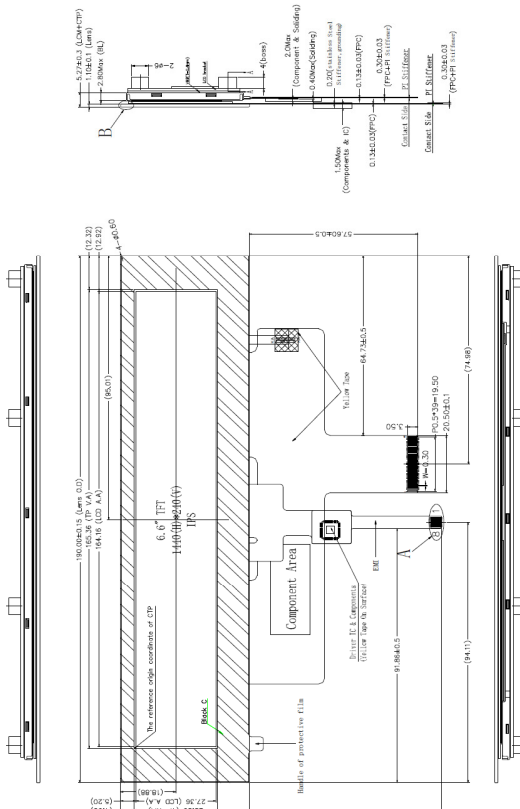
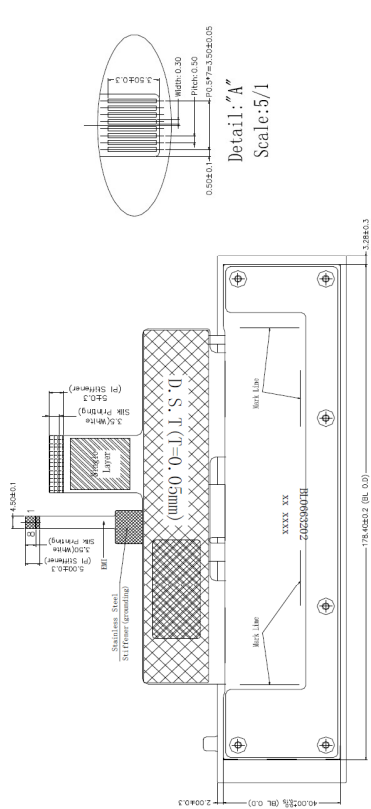
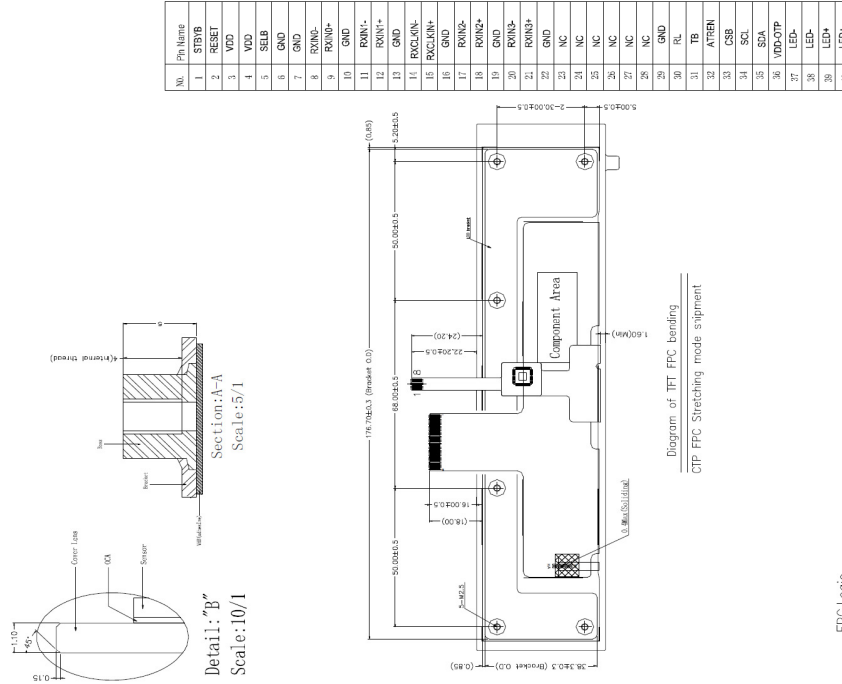
FPC Logic

| Pin | Logic |
|-----|-------|
| 1 | GND |
| 2 | NC |
| 3 | VDD |
| 4 | SCL |
| 5 | SDA |
| 6 | INT |
| 7 | RST |
| 8 | GND |

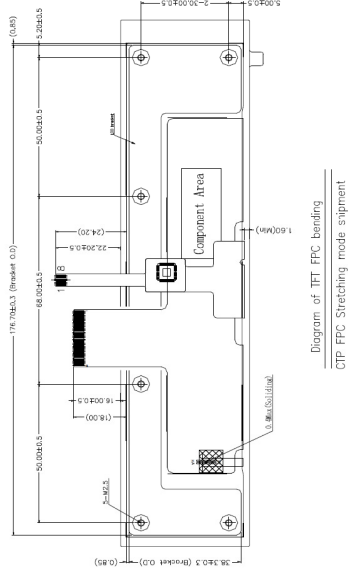


- NOTES:
1. DISPLAY TYPE: 6.6" TFT-LCD, 85/265K/16.7M COLORS
 2. DISPLAY MODE: Transmittive, TFT, RGB/CF/PS
 3. VIEWING DIRECTIONS: ALL
 4. LCM DRIVER IC: 24H8249+H8678 (C05)
 5. TOUCH DRIVER IC: FT911
 6. TOUCH INTERFACE IC: FT911
 7. TOUCH INTERFACE IIC
 8. TOUCH INTERFACE IIC
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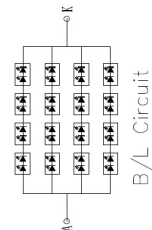
DMT066YYHLCMI-1B



| No. | Pin Name |
|-----|----------|
| 1 | STBYB |
| 2 | RESET |
| 3 | VDD |
| 4 | WDT |
| 5 | SELB |
| 6 | GND |
| 7 | GND |
| 8 | RXND- |
| 9 | RXND+ |
| 10 | GND |
| 11 | RXN1- |
| 12 | RXN1+ |
| 13 | GND |
| 14 | RXCLN- |
| 15 | RXCLN+ |
| 16 | GND |
| 17 | RXN2- |
| 18 | RXN2+ |
| 19 | GND |
| 20 | RXN3- |
| 21 | RXN3+ |
| 22 | GND |
| 23 | NC |
| 24 | NC |
| 25 | NC |
| 26 | NC |
| 27 | NC |
| 28 | NC |
| 29 | GND |
| 30 | RL |
| 31 | TB |
| 32 | ATRN |
| 33 | CSB |
| 34 | SCB |
| 35 | SCA |
| 36 | VDDCTP |
| 37 | LED- |
| 38 | LED+ |
| 39 | LED+ |
| 40 | LED+ |



| PIN | Logic |
|-----|-------|
| 1 | GND |
| 2 | NC |
| 3 | VDD |
| 4 | SCL |
| 5 | SDA |
| 6 | INT |
| 7 | RST |
| 8 | GND |



- NOTES:
1. DISPLAY TYPE: 6.6" TFT-LCD, 65/262K/16.7M COLORS
 2. DISPLAY MODE: NORMALLY BLACK/IPS
 3. VIEWING DIRECTION: ALL
 4. LCM DRIVER IC: Z1438249HH6878 (COG)
 5. LCM Interface: LVDS
 6. Touch Driver IC: CT811
 7. Touch Interface: IIC
 8. Touch and LCM Bonding technology: Optical Bonding
 9. VDD/VCI: 3.3V (REF. IC D.5)
 10. OPERATING TEMP: -30~+85 C
 11. STORAGE TEMP: -40~+90 C
 12. BACK LIGHT: LED WHITE, 16 Dual Chip LED(25.0V/80mA)
 13. Luminance: 800(MK/80mA),850cd/m2(TYP/60mA)
 14. Contrast: 1000(MK/80mA),3000cd/m2(TYP/90mA)
 15. RoHS COMPLIANT.

3.0 Electrical Specification

3.1 Absolute Maximum Ratings

3.1.1 TFT

| Item | Symbol | Min. | Max. | Unit | Note |
|-----------------------|---|------|------|------|-------|
| Power Supply Voltage | V _{DD} | -0.3 | 4.0 | V | - |
| Operating Temperature | T _{OP} | -30 | +85 | °C | 1 |
| Storage Temperature | T _{ST} | -40 | +90 | °C | 1,2,3 |
| Static Electricity | Be sure that you are grounded when handling displays. | | | | |

Note 1: 90% RH Max for Ta<50°C, and 60% RH for Ta≥50°C.

Note 2: In case of below 0°C, the response time of liquid crystal (LC) becomes slower and the colour of panel becomes darker than normal one. Level of retardation depends on temperature, because of LC's characteristics.

Note 3: Only operation is guaranteed at operating temperature. Contrast, response time, another display quality are evaluated at +25°C.

3.1.2 PCT

| Item | Symbol | Min. | Max. | Unit | Note |
|-----------------------|-----------------|------|------|------|------|
| Power Supply Voltage | V _{DD} | 2.66 | 3.47 | V | 4 |
| Operating Temperature | T _{OP} | -30 | +85 | °C | - |
| Storage Temperature | T _{ST} | -40 | +90 | °C | - |

Note 4: If used beyond the absolute maximum ratings, GT911 may be permanently damaged. It is strongly recommended that the device be used within the electrical characteristics in normal operations. If exposed to the condition not within the electrical characteristics, it may affect the reliability of the device.

3.2 Electrical Characteristics

3.2.1 TFT

| Item | Symbol | Min. | Typ. | Max. | Unit | Note |
|---------------------|----------|--------------------|------|--------------------|------|------|
| Supply Voltage | V_{DD} | 2.7 | 3.3 | 3.6 | V | |
| Normal mode Current | I_{DD} | - | 75 | - | mA | |
| High Level Input | V_{IH} | $0.7 \cdot V_{DD}$ | - | $V_{DD} + 0.3$ | V | |
| Low Level Input | V_{IL} | GND-0.3 | - | $0.3 \cdot V_{DD}$ | V | |
| High Level Output | V_{OH} | $V_{DD} - 0.4$ | - | - | V | |
| Low Level Output | V_{OL} | GND | - | GND+0.4 | V | |

3.2.2 PCT

| Item | Symbol | Min. | Typ. | Max. | Unit | Note |
|-------------------------------|----------|---------------------|------|---------------------|---------|------|
| Supply Voltage | V_{DD} | 2.66 | 3.3 | 3.47 | V | |
| Normal mode operating current | - | - | 8 | 14.5 | mA | |
| Green mode operating current | - | - | 3.3 | - | mA | |
| Sleep mode operating current | - | 70 | - | 120 | μ A | |
| Doze mode operating current | - | - | 0.78 | - | mA | |
| Digital Input low voltage | V_{IL} | -0.3 | - | $0.25 \cdot V_{DD}$ | V | |
| Digital Input high voltage | V_{IH} | $0.75 \cdot V_{DD}$ | - | $V_{DD} + 0.3$ | V | |
| Digital Output low voltage | V_{OL} | - | - | $0.15 \cdot V_{DD}$ | V | |
| Digital Output high voltage | V_{OH} | $0.85 \cdot V_{DD}$ | - | | V | |
| Oscillation frequency | OSC | 59 | 60 | 61 | MHz | |
| I/O output rise time | - | - | 14 | - | ns | |
| I/O output fall time | - | - | 14 | - | ns | |

Ambient temperature: 25°C, VDD=2.8V, VDDIO=1.8V or VDDIO=VDD

3.3 Interface Pin Assignment

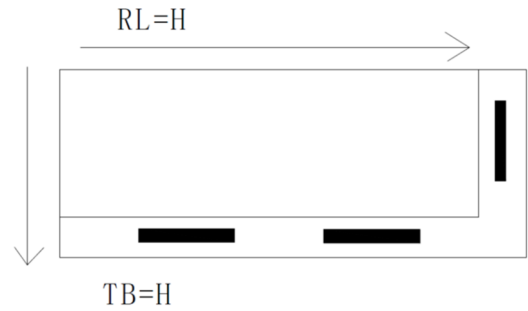
3.3.1 TFT Pin Assignment

| No. | Symbol | Function | |
|-----|----------|--|-----------------|
| 1 | STBYB | Enable IC. HIGH = 3.3V LOW = GND | |
| 2 | RESET | Hardware Reset input. RC reset circuit is suggested for stability (47kΩ + 0.1μF). Normally pull high. | |
| 3 | VDD | Digital supply voltage. Typical value of 3.3V. | |
| 4 | VDD | Digital supply voltage. Typical value of 3.3V. | |
| 5 | SELB | 6bit/8bit mode select. | |
| | | SELB | Function |
| | | 0 | 6 bit |
| | | 1 | 8 bit |
| 6 | GND | Ground of Logic Circuit. This is a ground pin, to be connected to external ground. | |
| 7 | GND | Ground of Logic Circuit. This is a ground pin, to be connected to external ground. | |
| 8 | RXIN0- | Negative LVDS differential data input. | |
| 9 | RXIN0+ | Positive LVDS differential data input. | |
| 10 | GND | Ground of Logic Circuit. This is a ground pin, to be connected to external ground. | |
| 11 | RXIN1- | Negative LVDS differential data input. | |
| 12 | RXIN1+ | Positive LVDS differential data input. | |
| 13 | GND | Ground of Logic Circuit. This is a ground pin, to be connected to external ground. | |
| 14 | RXCLKIN- | Negative LVDS differential clock input. | |
| 15 | RXCLKIN+ | Positive LVDS differential clock input. | |
| 16 | GND | Ground of Logic Circuit. This is a ground pin, to be connected to external ground. | |
| 17 | RXIN2- | Negative LVDS differential data input. | |
| 18 | RXIN2+ | Positive LVDS differential data input. | |
| 19 | GND | Ground of Logic Circuit. This is a ground pin, to be connected to external ground. | |

| No. | Symbol | Function |
|-----|---------|--|
| 20 | RXIN3- | Negative LVDS differential data input. |
| 21 | RXIN3+ | Positive LVDS differential data input. |
| 22 | GND | Ground of Logic Circuit. This is a ground pin, to be connected to external ground. |
| 23 | NC | Not Connected. These pins are left not connected. |
| 24 | NC | Not Connected. These pins are left not connected. |
| 25 | NC | Not Connected. These pins are left not connected. |
| 26 | NC | Not Connected. These pins are left not connected. |
| 27 | NC | Not Connected. These pins are left not connected. |
| 28 | NC | Not Connected. These pins are left not connected. |
| 29 | GND | Ground of Logic Circuit. This is a ground pin, to be connected to external ground. |
| 30 | RL | Horizontal shift direction. (Note 1) |
| 31 | TB | Vertical shift direction. (Note 1) |
| 32 | ATREN | ATREN should be kept HIGH. |
| 33 | CSB | No connection. |
| 34 | SCL | No connection. |
| 35 | SDA | No connection. |
| 36 | VDD-OTP | 7.5V for OTP program (Not connected). |
| 37 | LED- | LED backlight Negative Supply pin. These pins are to be connected to external source. |
| 38 | LED- | LED backlight Negative Supply pin. These pins are to be connected to external source. |
| 39 | LED+ | LED backlight Positive Supply pin. These pins are to be connected to external source. |
| 40 | LED+ | LED backlight Positive Supply pin. These pins are to be connected to external source. |

Note 1:

| Scan control input | | Scanning direction |
|--------------------|-----|---------------------------|
| RL | TB | |
| VDD | VDD | Up to Down, Left to Right |
| GND | VDD | Up to Down, Right to Left |
| VDD | GND | Down to Up, Left to Right |
| GND | GND | Down to Up, Right to Left |



3.3.2 PCT Pin assignment

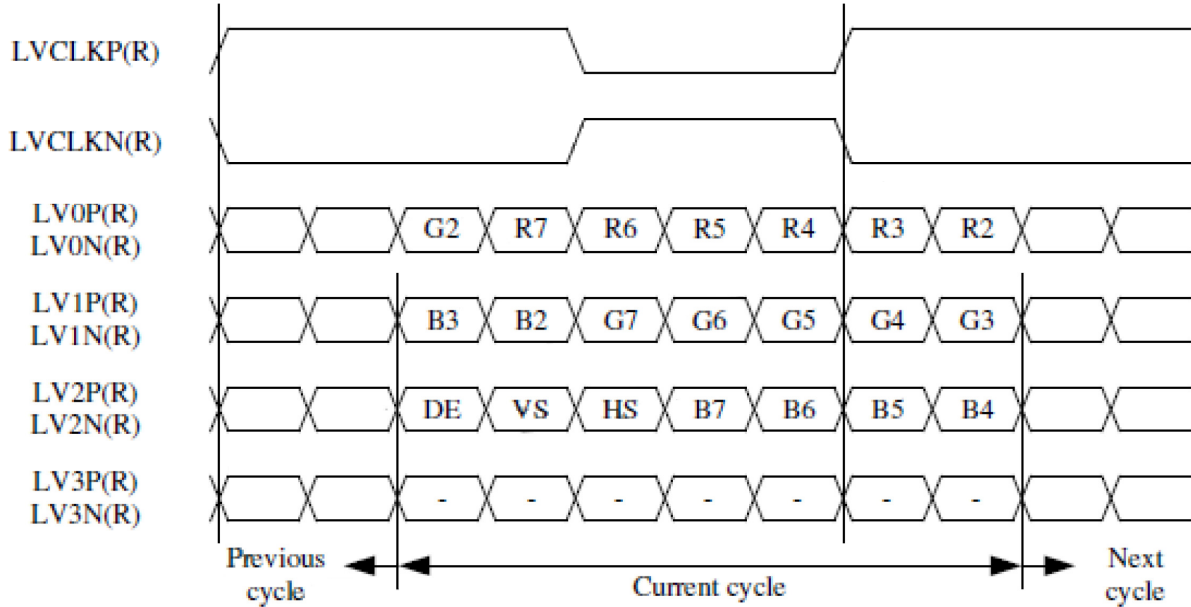
| No. | Symbol | Function |
|-----|--------|---|
| 1 | GND | Ground of Logic Circuit. This is a ground pin, to be connected to external ground. |
| 2 | NC | Not Connected. These pins are left not connected. |
| 3 | VDD | Digital supply voltage. |
| 4 | SCL | I2C Clock input. |
| 5 | SDA | I2C Data input and output. |
| 6 | INT | External interrupt to the host |
| 7 | RST | External Reset, Low is active |
| 8 | GND | Ground of Logic Circuit. This is a ground pin, to be connected to external ground. |

3.4 TFT Timing Characteristics

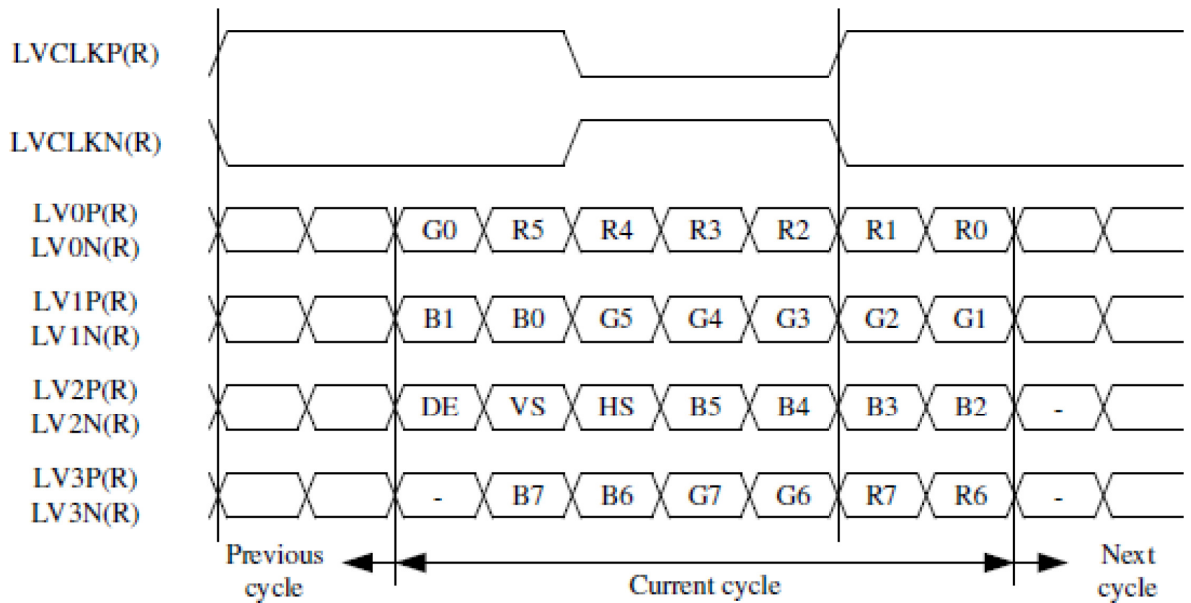
Please refer to Himax IC HX8249 and HX8678 datasheet for more information.

3.4.1 LVDS 6-bit vs. 8-bit mode

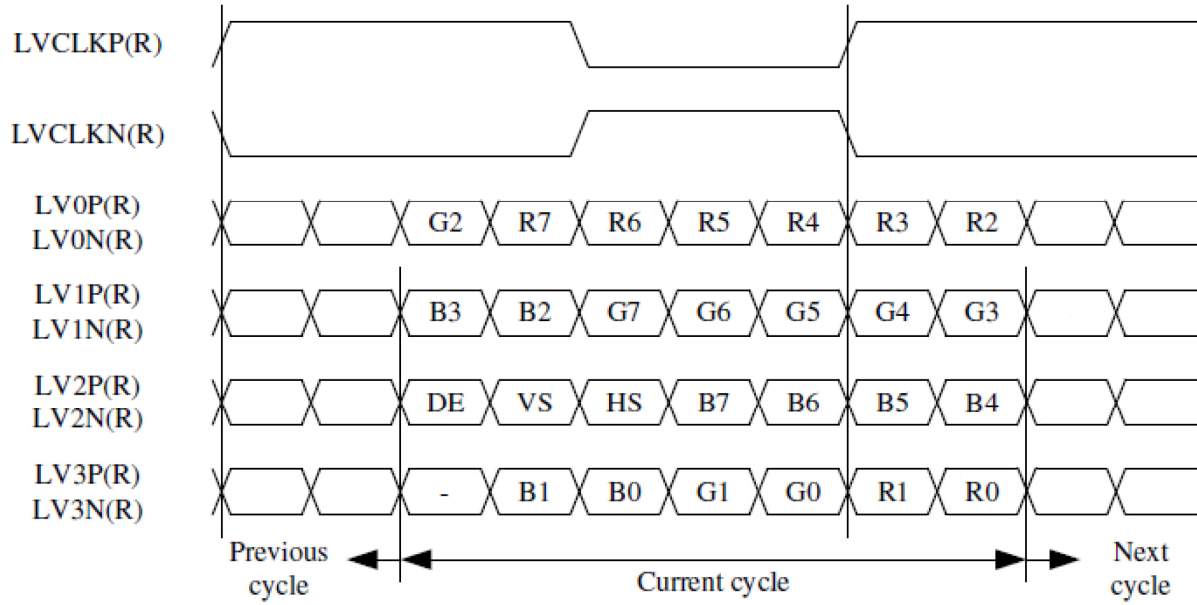
- 6-bit LVDS



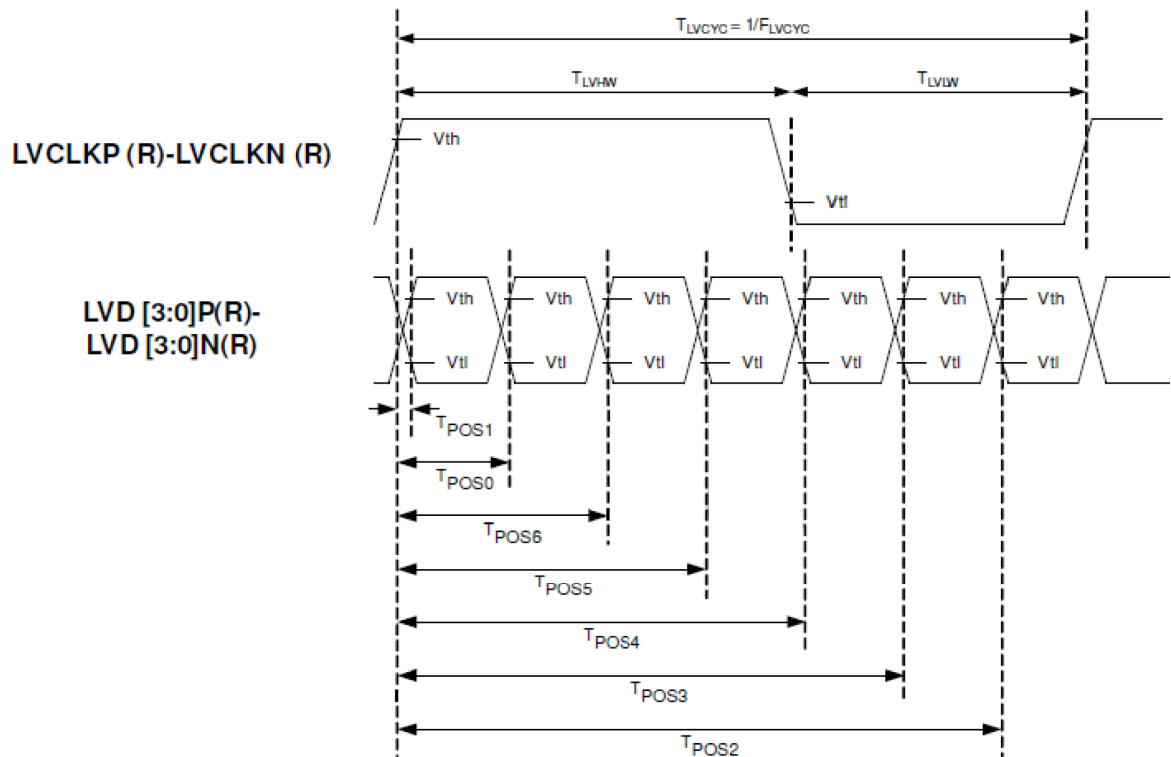
- 8-bit LVDS (VESA format)



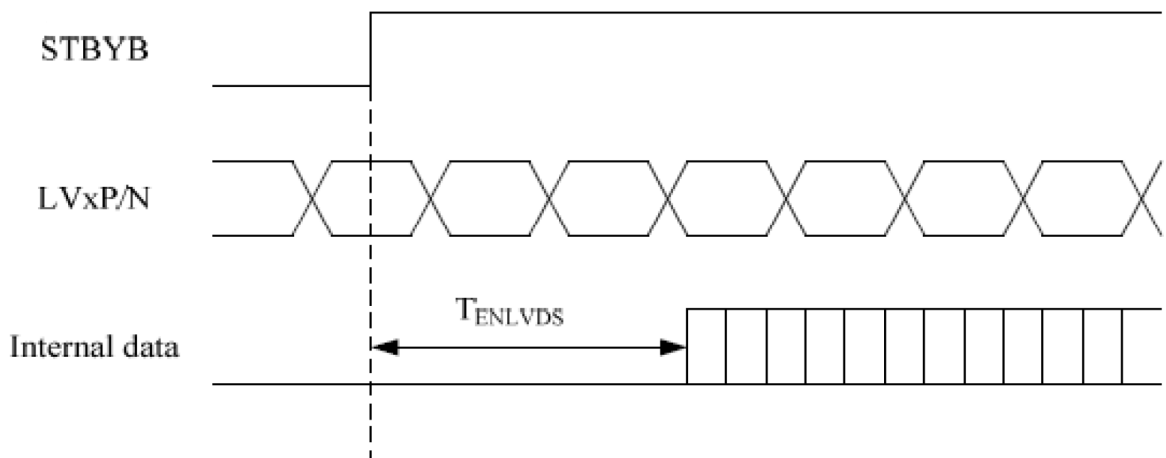
- 8-bit LVDS (JEIDA format)



3.4.2 LVDS input timing

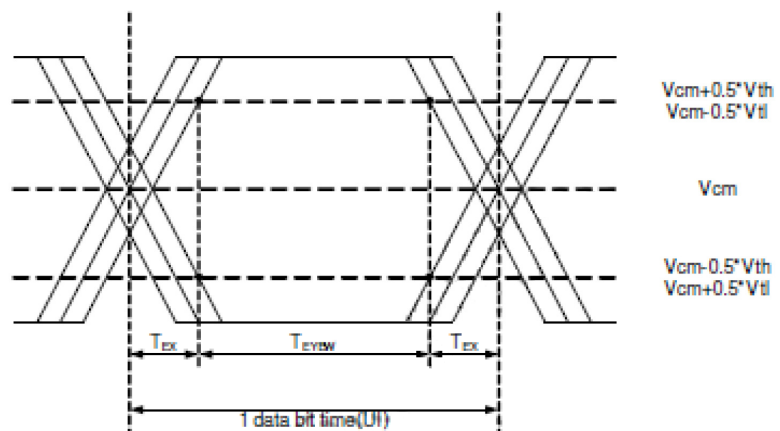


- LVDS wake up time

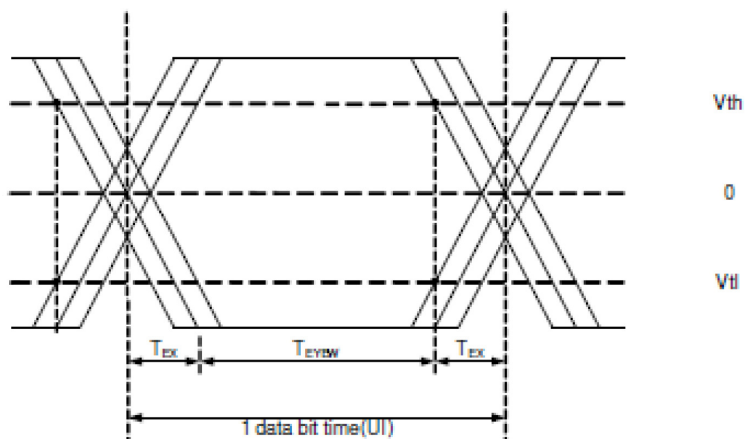


- LVDS input eye diagram

**Single-ended:
LVD [3:0]P,
LVD [3:0]N**



**Differential:
LVD [3:0]P-LVD [3:0]N**

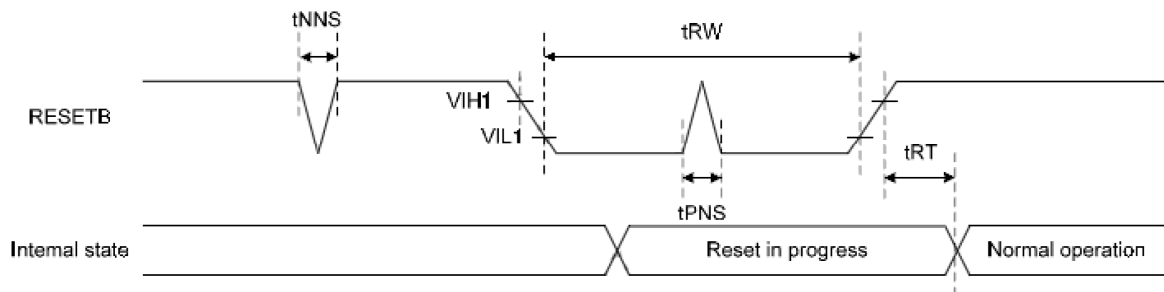


- LVDS input timing parameters

| Parameter | Symbol | Spec. | | | Unit |
|-------------------|---------|-------|------|------|---------|
| | | Min. | Typ. | Max. | |
| Clock frequency | FLVCYC | 10 | - | 85 | MHz |
| Clock period | TLVCYC | 11.76 | - | 100 | ns |
| 1 data bit time | UI | - | 1/7 | - | TLVCYC |
| Clock high time | LVHW | 2.9 | 4 | 4.1 | UI |
| Clock low time | LVHW | 2.9 | 3 | 4.1 | UI |
| Position 1 | TPOS1 | -0.2 | 0 | 0.2 | UI |
| Position 0 | TPOS0 | 0.8 | 1 | 1.2 | UI |
| Position 6 | TPOS6 | 1.8 | 2 | 2.2 | UI |
| Position 5 | TPOS5 | 2.8 | 3 | 3.2 | UI |
| Position 4 | TPOS4 | 3.8 | 4 | 4.2 | UI |
| Position 3 | TPOS3 | 4.8 | 5 | 5.2 | UI |
| Position 2 | TPOS2 | 5.8 | 6 | 6.2 | UI |
| Input eye width | TEYEW | 0.6 | - | - | UI |
| Input eye border | TEX | - | - | 0.2 | UI |
| LVDS wake up time | TENLVDS | - | - | 150 | μ s |

| Symbol | Description | Min | Typ | Max | Unit |
|-----------|-----------------------|-----|------|-----|------|
| FDCLK | DCLK frequency | - | 22 | - | MHz |
| t_{hd} | Horizontal valid data | - | 1440 | - | DCLK |
| t_{hpw} | Hsync pulse width | - | 2 | - | DCLK |
| t_{hbp} | Hsync back porch | - | 16 | - | DCLK |
| t_{hfp} | Hsync front porch | - | 44 | - | DCLK |
| t_h | 1 horizontal line | - | 1500 | - | DCLK |
| t_{vd} | Vertical valid data | - | 240 | - | H |
| t_{vpw} | Vsync pulse width | - | 2 | - | H |
| t_{vbp} | Vsync back porch | - | 5 | - | H |
| t_{vfp} | Vsync front porch | - | 31 | - | H |
| t_v | 1 vertical field | - | 276 | - | H |

3.4.3 Reset Timing Characteristics

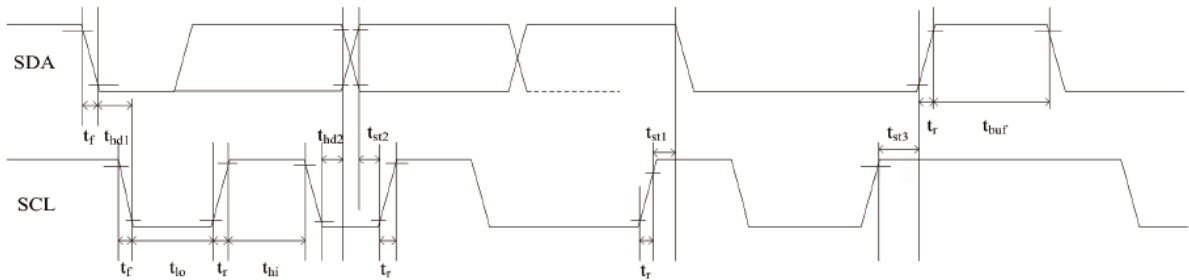


| Signal | Parameter | Symbol | Min | Max | Unit |
|--------|----------------------------|-----------|-----|-----|---------|
| RESETB | Rested pulse width | t_{RW} | 10 | - | μs |
| | Reset complete time | t_{RT} | - | 5 | μs |
| | Positive spike noise width | t_{PNS} | - | 100 | ns |
| | Negative spike noise width | t_{NNS} | - | 100 | ns |

VDD1=VDD2=2.7 to 3.6V, GND=0V, T_A =-40 to +95 °C

3.5 PCT Timing Characteristics

GT911 provides a standard I2C interface for SCL and SDA to communicate with the host. GT911 always serves as a slave device in the system with all communication being initialized by the host. It is strongly recommended that transmission is kept at or below 400Kbps. The I2C timing is shown below:



Test condition 1: 1.8V host interface voltage, 400Kbps transmission rate, 2k pull-up resistor

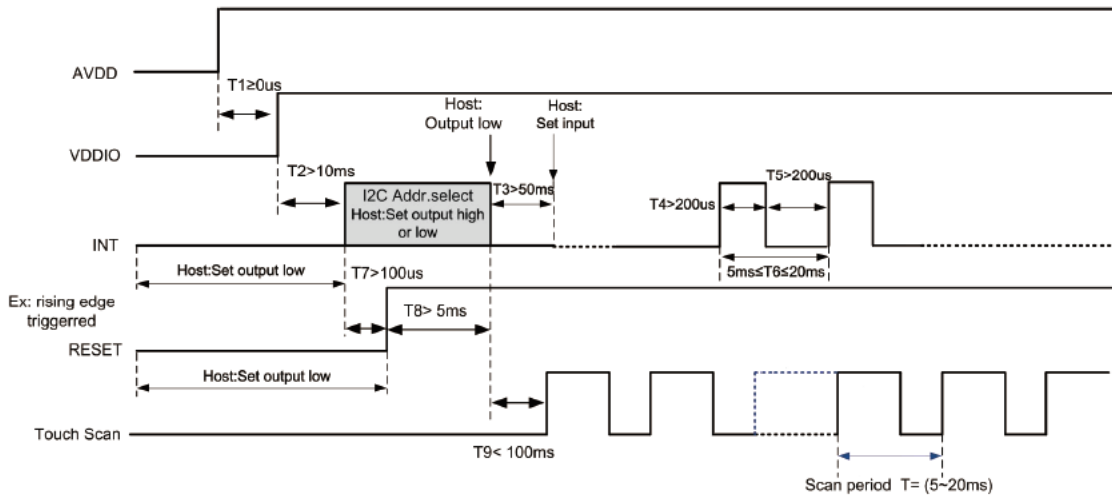
| Parameter | Symbol | Min | Max | Unit |
|------------------------------------|-----------|-----|-----|---------|
| SCL low period | t_{lo} | 1.3 | - | μs |
| SCL high period | t_{hi} | 0.6 | - | μs |
| SCL setup time for Start condition | t_{st1} | 0.6 | - | μs |
| SCL setup time for Stop condition | t_{st3} | 0.6 | - | μs |
| SCL hold time for Start condition | t_{hd1} | 0.6 | - | μs |
| SDA setup time | t_{st2} | 0.1 | - | μs |
| SDA hold time | t_{hd2} | 0 | - | μs |

Test condition 2: 3.3V host interface voltage, 400Kbps transmission rate, 2k pull-up resistor

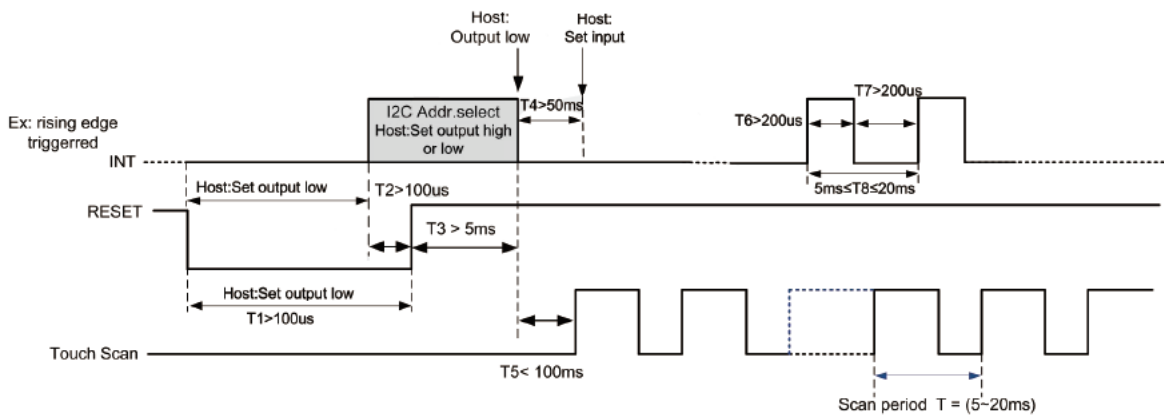
| Parameter | Symbol | Min | Max | Unit |
|------------------------------------|-----------|-----|-----|---------|
| SCL low period | t_{lo} | 1.3 | - | μs |
| SCL high period | t_{hi} | 0.6 | - | μs |
| SCL setup time for Start condition | t_{st1} | 0.6 | - | μs |
| SCL setup time for Stop condition | t_{st3} | 0.6 | - | μs |
| SCL hold time for Start condition | t_{hd1} | 0.6 | - | μs |
| SDA setup time | t_{st2} | 0.1 | - | μs |
| SDA hold time | t_{hd2} | 0 | - | μs |

GT911 supports two I2C slave addresses: 0xBA/0xBB and 0x02/0x29. The host can select the address by changing the status of Reset and INT pins during the power-on initialisation phase. See the diagram below for configuration methods and timings:

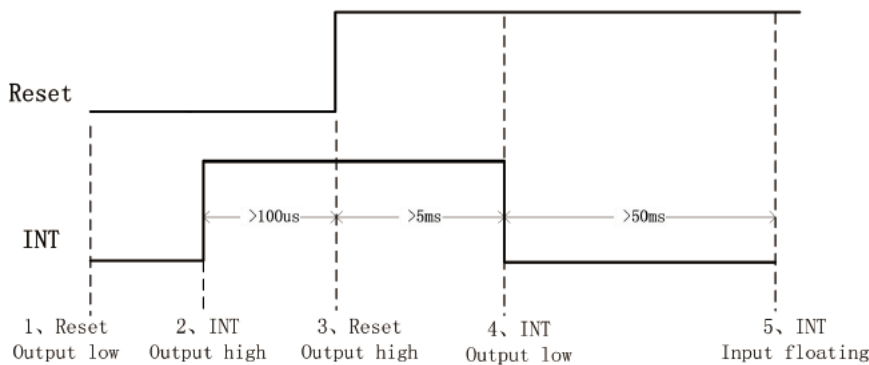
Power-on Timing:



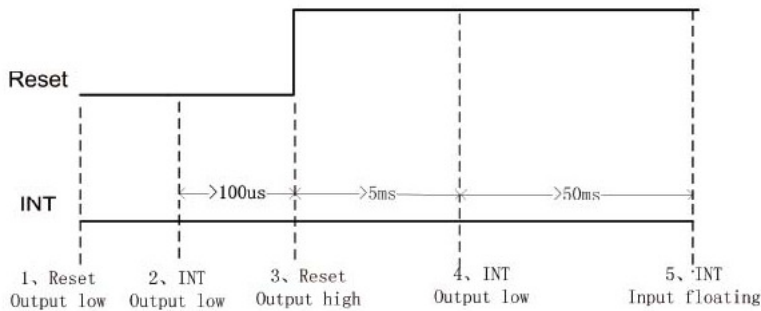
Timing for host resetting GT911:



Timing for setting slave address to 0x28/0x29:



Timing for setting slave address to 0xBA/0xBB:



3.5.1 Data transmission

(For example: device address is 0xBA/0xBB)

Communication is always initiated by the host. Valid Start condition is signalled by pulling SDA line from “high” to “low” when SCL line is “high”. Data flow or address is transmitted after the Start condition.

All slave devices connected to I2C bus should detect the 8-bit address issued after Start condition and send the correct ACK. After receiving matching address, GT911 acknowledges by configuring SDA line as output port and pulling SDA line low during the ninth SCL cycle. When receiving unmatched address, namely, not 0xBS or 0xBB, GT911 will stay in an idle state.

For data bytes on SDA, each of 9 serial bits will be sent on nine SCL cycles. Each data byte consists of 8 valid data bits and one ACK or NACK bit sent by the recipient. The data transmission is valid when SCL line is “high”.

When communication is completed, the host will issue the STOP condition. Stop condition implies the transition of SDA line from “low” to “high” when SCL line is “high”.

3.5.2 Writing Data to GT911

(For example: device address is 0xBA/0xBB)

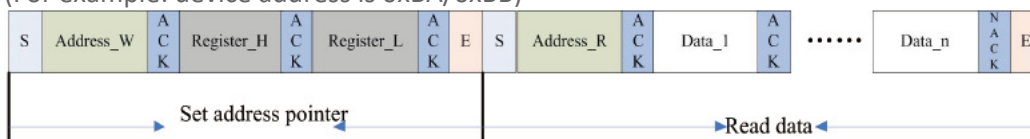


The diagram above displays the timing sequence of the host writing data onto GT911. First the host issues a Start condition. Then, the host sends 0xBA (address bits and R/W bit; R/W bit as 0 indicates Write operation) to the slave device.

The location of the register address pointer will automatically add 1 after every Write Operation. Therefore, when the host needs to perform Write Operations on a group of registers of continuous addresses, it can write continuously. The Write Operations terminated when the host issues the Stop condition.

3.5.3 Reading Data from GT911

(For example: device address is 0xBA/0xBB)



The diagram above is the timing sequence of the host reading data from GT911. First, the host issues a start condition and sends 0xBA (address bits and R/W bit; R/W bit as 0 indicates Write operation) to the device.

After receiving ACK, the host sends the 16-bit register address (where reading starts) to the slave device. Then the host sets register addresses which need to be read.

Also after receiving ACK, the host issues the Start condition once again and sends 0xBB (Read Operation). After receiving ACK, the host starts to read data.

GT911 also supports continuous Read Operation and, by default, reads data continuously.

Whenever receiving a byte of data, the host sends an ACK signal indicating successful reception.

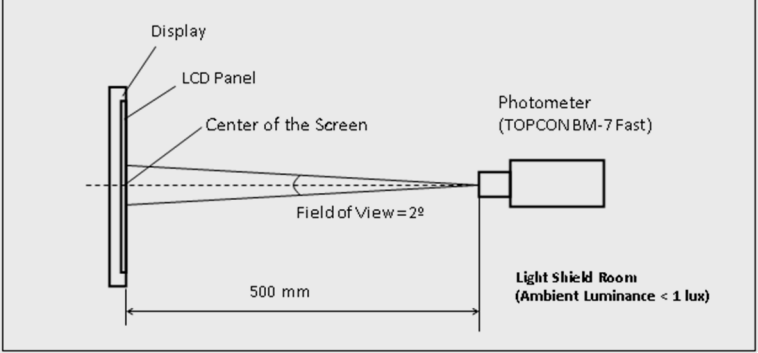
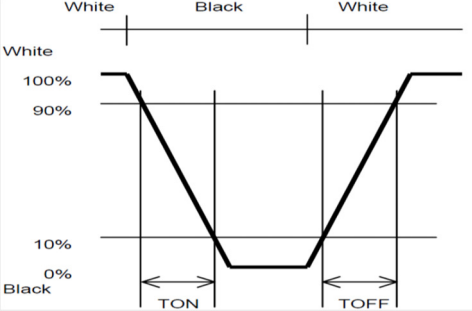
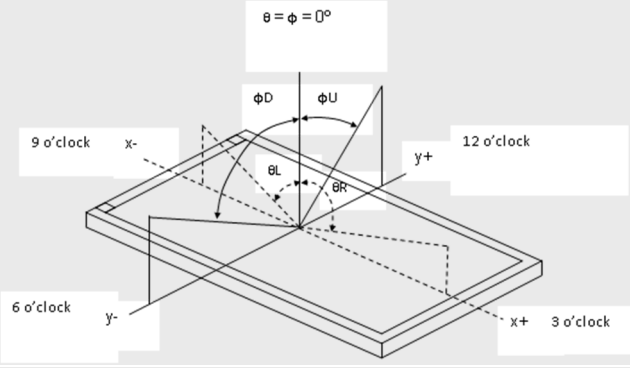
After receiving the last byte of data, the host sends a NACK signal followed by a STOP condition which terminates communication.

4.0 Optical Specification

4.1 Optical Characteristics

Measuring instruments: LCD-5100, Eldim, Topcon BM-7
 Driving condition: $V_{DD} = 3.3V$, $V_{SS} = 0V$
 Backlight: $IF = 75mA$
 Measured temperature: $T_a = 25^{\circ}C$

| Characteristics | | Symbol | Conditions | Min | Typ | Max | Unit | Note |
|-------------------------|-------|------------|---------------------------------------|------------|-------------|-------|-------------------|------|
| Response time | | TR+TF | $\theta = \Phi = 0^{\circ}$ Normal | - | 25 | - | ms | 2 |
| Contrast Ratio | | CR | Viewing Angle | 600 | 800 | - | - | 3 |
| Uniformity | | S(%) | | - | 60 | - | % | |
| Viewing Angle | Left | θ_L | CR \geq 10 | - | 80 | - | deg | 4 |
| | Right | θ_R | | - | 80 | - | | |
| | Up | θ_U | | - | 80 | - | | |
| | Down | θ_D | | - | 80 | - | | |
| Colour Chromaticity | Red | Rx | CR \geq 10 | 0.552 | 0.592 | 0.632 | - | 5 |
| | | Ry | | 0.287 | 0.327 | 0.367 | | |
| | Green | Gx | | 0.319 | 0.359 | 0.399 | | |
| | | Gy | | 0.553 | 0.593 | 0.633 | | |
| | Blue | Bx | | 0.108 | 0.148 | 0.188 | | |
| | | By | | 0.061 | 0.101 | 0.141 | | |
| | White | Wx | | 0.271 | 0.311 | 0.351 | | |
| | | Wy | | 0.293 | 0.333 | 0.373 | | |
| Centre Brightness | | | - | - | - | - | - | |
| DMT066YYHLNTO-1A/B | | | | 900 | 1000 | - | Cd/m ² | 6 |
| DMT066YYHLNTO-1A/B | | | | 850 | 900 | - | Cd/m ² | 6 |
| Brightness Distribution | | | | 80 | - | - | % | 7 |

| Note | Item | Test method |
|------|---|---|
| 1 | Setup | <p>The display should be stabilised at a given temperature for 30 minutes to avoid abrupt temperature change during measuring. To stabilise the luminance, measurements should be executed after lighting the backlight for 30 minutes in a windless room.</p>  |
| 2 | Response time | <p>Measure output signal waveform by the luminance meter when raster of window pattern is changed from white to black and from black to white.</p>  |
| 3 | Contrast ratio | <p>Measure maximum brightness and minimum brightness at the centre of the screen by displaying raster or window pattern. Then calculate the ratio between these two values.</p> $\text{Contrast Ratio (CR)} = \frac{\text{Brightness of unselected position (white)}}{\text{Brightness of selected position (black)}}$ |
| 4 | Viewing angle Horizontal θ Vertical ϕ | <p>Move the luminance meter from right to left and up and down and determine the angles where contrast ratio is 10</p>  |
| 5 | Colour chromaticity | <p>Measure chromaticity coordinates x and y of CIE1931 colorimetric system</p> |
| 6 | Brightness distribution | <p>(Brightness distribution) = $100 \times B/A \%$ A: max. brightness of the 9 points B: min. brightness of the 9 points</p> |

5.0 LED Backlight Specification

5.1 LED Backlight Characteristics

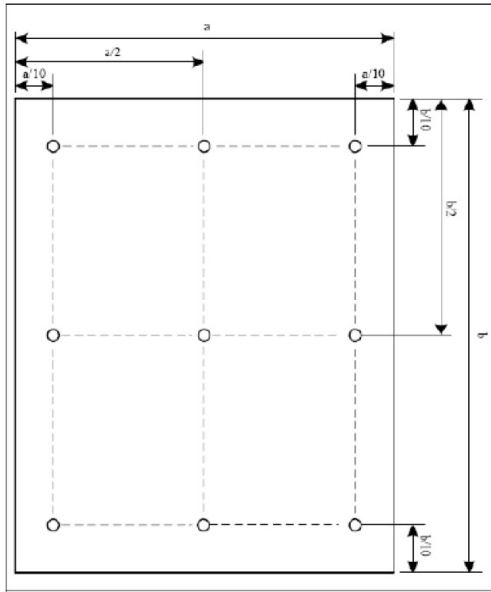
The back-light system is edge-lighting type with 32 chips LED

| Characteristics | Symbol | Min | Typ. | Max | Unit | Note |
|------------------------------|----------------|------------|-------------|-----|-------------------|------|
| Forward Current | I _F | 60 | 80 | - | mA | |
| Forward Voltage | V _F | - | 25.6 | - | V | |
| LCM Luminance at 60mA | - | - | - | - | - | - |
| DMT066YYHLNTO-1A/B | LV | 800 | 900 | - | Cd/m ² | 3 |
| DMT066YYHLCMI-1A/B | LV | 800 | 850 | - | Cd/m ² | 3 |
| LCM Luminance at 80mA | - | - | - | - | - | - |
| DMT066YYHLNTO-1A/B | LV | 900 | 1000 | - | Cd/m ² | 3 |
| DMT066YYHLCMI-1A/B | LV | 850 | 900 | - | Cd/m ² | 3 |
| LED life time | Hr | - | 50000 | - | Hour | 1,2 |
| Uniformity | Avg | 80 | - | - | % | 3 |

Note 1: LED life time (Hr) can be defined as the time in which it continues to operate under the condition: T_a=25±3 °C, typical IL value indicated in the above table until the brightness becomes less than 50%.

Note 2: The “LED life time” is defined as the module brightness decrease to 50% original brightness at T_a=25°C and IL=80mA. The LED lifetime could be decreased if operating IL is larger than 80mA. The constant current driving method is suggested.

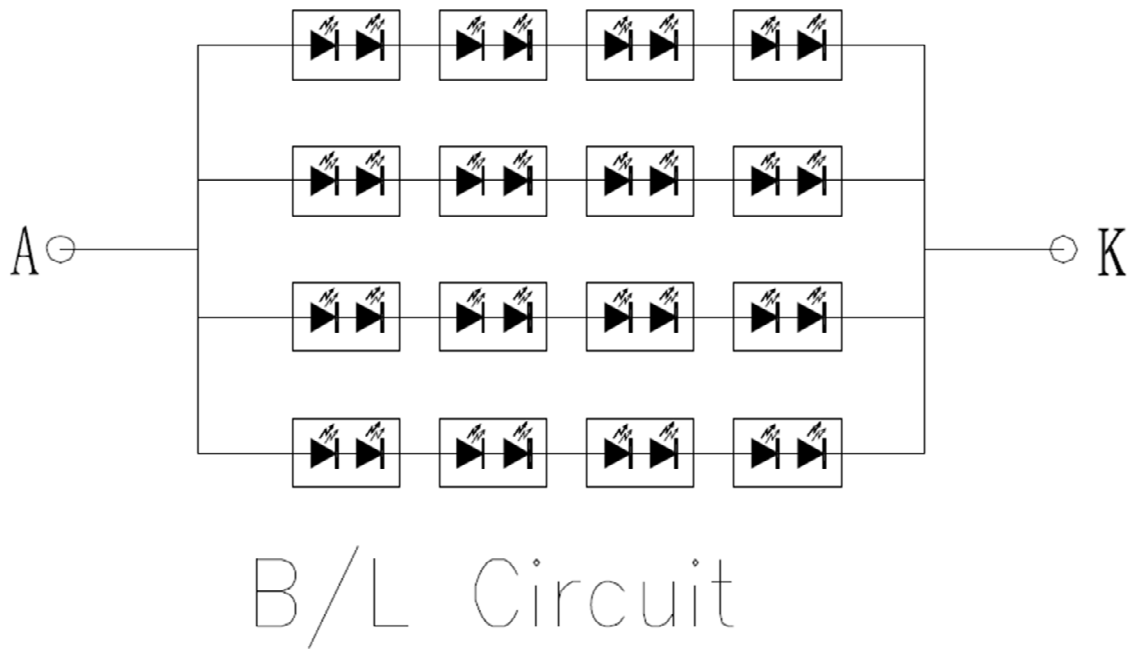
Note 3: Luminance Uniformity of these 9 points is defined as below:



$$\text{Uniformity} = \frac{\text{minimum luminance in 9 points (1-9)}}{\text{maximum luminance in 9 points (1-9)}}$$

$$\text{Luminance} = \frac{\text{Total Luminance of 9 points}}{9}$$

5.2 Internal Circuit Diagram



6.0 Quality Assurance Specification

6.1 Delivery Inspection Standards

6.1.1 Inspection Conditions

Inspection distance: 30 cm ± 2cm
Viewing angle: ±45°

6.1.2 Environmental Conditions

Ambient temperature: 25°C ± 5°C
Ambient humidity: 65±10% RH
Ambient illumination: 300~700 lux

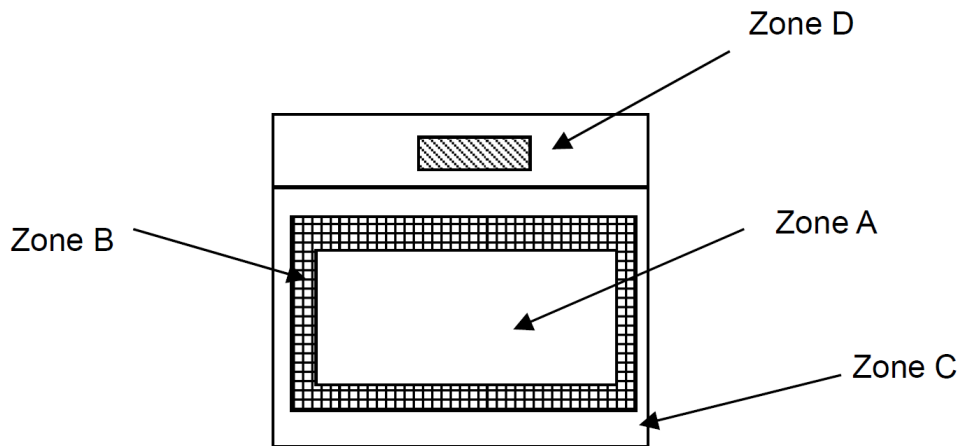
6.1.3 Sampling Conditions

1. Lot size: quantity of shipment lot per model
2. Sampling method:

| Sampling plan | | GB/T 2828-2003 |
|---------------|--------------|-----------------------------|
| | | Normal inspection, Class II |
| AQL | Major Defect | 0.65% |
| | Minor Defect | 1.5% |

| No. | Items to be inspected | Criteria | Classification of defects |
|-----|-----------------------|---|---------------------------|
| 1 | Functional defects | 1) No display, Open or miss line 2) Display abnormally, Short 3) Backlight no lighting, abnormal lighting. 4) TP no function | Major |
| 2 | Missing | Missing component | |
| 3 | Outline dimension | Overall outline dimension beyond the drawing is not allowed | |
| 4 | Colour tone | Colour unevenness, refer to limited sample | Minor |
| 5 | Spot Line defect | Light dot, Dim spot, Polarizer bubble; Polarizer accidented spot. | |
| 6 | Soldering appearance | Good soldering, peeling off is not allowed. | |
| 7 | LCD/Polarizer/TP | Black/White spot/line, scratch, crack, etc. | |

6.1.4 Zone Definition



Zone A: Effective Viewing Area (Character or Digit can be seen)

Zone B: Viewing Area except Zone A

Zone C: Outside (ZoneA+ZoneB) which can't be seen after assembly by customer.

Zone D: IC Bonding Area

Note: Generally, visual defects in Zone C can be ignored when it doesn't affect product function or appearance after assembly by customer.


6.1.5 Basic Principle


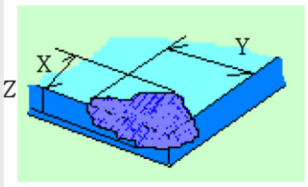
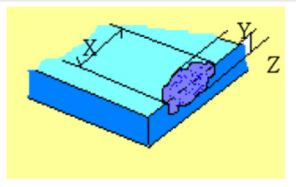
A set of sample to indicate the limit of acceptable quality level shall be discussed should a dispute occur.

6.1.6 Inspection Criteria

| Number | Items | Criteria (mm) | | | | | | |
|---|---|---|----|---|--------|--------|--------------------------------|----|
| 1.0 LCD Crack/ Broken Note: X: Length Y: Width Z: Height L: Length of ITO T: Height of LCD | (1) The edge of LCD broken | <div data-bbox="603 385 1177 696" data-label="Image"> </div> <table border="1" data-bbox="528 696 1412 815"> <thead> <tr> <th data-bbox="528 696 890 741">X</th> <th data-bbox="890 696 1155 741">Y</th> <th data-bbox="1155 696 1412 741">Z</th> </tr> </thead> <tbody> <tr> <td data-bbox="528 741 890 815">≤3.0mm</td> <td data-bbox="890 741 1155 815"><Inner border line of the seal</td> <td data-bbox="1155 741 1412 815">≤T</td> </tr> </tbody> </table> | X | Y | Z | ≤3.0mm | <Inner border line of the seal | ≤T |
| | X | Y | Z | | | | | |
| | ≤3.0mm | <Inner border line of the seal | ≤T | | | | | |
| (2) LCD corner broken | <div data-bbox="614 871 1166 1189" data-label="Image"> </div> <table border="1" data-bbox="528 1189 1412 1272"> <thead> <tr> <th data-bbox="528 1189 890 1234">X</th> <th data-bbox="890 1189 1155 1234">Y</th> <th data-bbox="1155 1189 1412 1234">Z</th> </tr> </thead> <tbody> <tr> <td data-bbox="528 1234 890 1272">≤3.0mm</td> <td data-bbox="890 1234 1155 1272">≤L</td> <td data-bbox="1155 1234 1412 1272">≤T</td> </tr> </tbody> </table> | X | Y | Z | ≤3.0mm | ≤L | ≤T | |
| X | Y | Z | | | | | | |
| ≤3.0mm | ≤L | ≤T | | | | | | |
| (3) LCD crack | <div data-bbox="651 1301 1121 1659" data-label="Image"> <p data-bbox="790 1541 949 1615">Crack Not allowed</p> </div> | | | | | | | |

| Number | Items | Criteria (mm) | | | | |
|-----------------------|---|--|------|--------------------------|---|---|
| 2.0 | Spot defects  $\Phi = (X+Y) / 2$ | ① Light dot (LCD/TP/Polarizer black/white spot, light dot, pinhole, dent, stain) | | | | |
| | | Size (mm) | Zone | Acceptable Qty | | |
| | | | | A | B | C |
| | | $\Phi \leq 0.10$ | | Ignore | | |
| | | $0.10 < \Phi \leq 0.25$ | | 4(distance ≥ 10 mm) | | |
| | | $0.25 < \Phi \leq 0.35$ | | 3 | | |
| | | $\Phi > 0.4$ | | 0 | | |
| | | ② Dim spot (LCD/TP/Polarizer dim dot, light leakage, dark spot) | | | | |
| | | Size (mm) | Zone | Acceptable Qty | | |
| | | | | A | B | C |
| | | $\Phi \leq 0.1$ | | Ignore | | |
| | | $0.10 < \Phi \leq 0.25$ | | 4(distance ≥ 10 mm) | | |
| | | $0.25 < \Phi \leq 0.35$ | | 3 | | |
| | | $\Phi > 0.40$ | | 0 | | |
| | | ③ Polarizer accidented spot | | | | |
| | | Size (mm) | Zone | Acceptable Qty | | |
| | | | | A | B | C |
| | | $\Phi \leq 0.2$ | | Ignore | | |
| | | $0.3 < \Phi \leq 0.5$ | | 3(distance ≥ 10 mm) | | |
| | | $\Phi > 0.5$ | | 1 | | |
| | | ④ Pixel bad points (light dot, Dim dot, colour dot) | | | | |
| | | Size (mm) | Zone | Acceptable Qty | | |
| | | | | A | B | C |
| | | $\Phi \leq 0.15$ | | Ignore | | |
| | | $0.2 < \Phi \leq 0.3$ | | 2(distance ≥ 10 mm) | | |
| | | $\Phi > 0.4$ | | 1 | | |
| | | ⑤ Polarizer Bubble | | | | |
| | | Size (mm) | Zone | Acceptable Qty | | |
| | | A | B | C | | |
| $\Phi \leq 0.2$ | | Ignore | | | | |
| $0.3 < \Phi \leq 0.4$ | | 4(distance ≥ 10 mm) | | | | |
| $0.4 < \Phi \leq 0.5$ | | 3 | | | | |
| $\Phi > 0.5$ | | 1 | | | | |

| | | | | | | | |
|-----------------------------|--|--|--|--------------------------|---|--------|--|
| 3.0 | Line defect (LCD/TP/ Polarizer black/ white line, scratch, stain) | Width (mm) | Length (mm) | Acceptable Qty | | | |
| | | | | A | B | C | |
| | | $\Phi \leq 0.05$ | Ignore | Ignore | | Ignore | |
| | | $0.05 < W \leq 0.06$ | $L \leq 5.0$ | $N \leq 2$ | | | |
| | | $0.07 < W \leq 0.08$ | $L \leq 4.0$ | $N \leq 2$ | | | |
| $0.08 < W$ | Define as spot defect | | | | | | |
| 4.0 | SMT | Do not allow: missing parts, solderless connection, cold solder joint, miss match, the positive and negative polarity oppose | | | | | |
| 5.0 | Display colour & Brightness | 1. Colour: Measuring the colour coordinates, The measurement standard according to the datasheet or samples 2. Brightness: Measuring the brightness of White screen, The measurement standard according to the datasheet or Samples | | | | | |
| 6.0 | LCD Mura | By 5% ND filter invisible | | | | | |
| 7.0 | RTP Related | TP bubble/ accidented spot | | | | | |
| | | Size Φ (mm) | Zone | Acceptable Qty | | | |
| | | | | A | B | C | |
| | | $\Phi \leq 0.1$ | | Ignore | | Ignore | |
| | | $0.1 < \Phi \leq 0.25$ | | 4(distance ≥ 10 mm) | | | |
| | | $0.25 < \Phi \leq 0.35$ | | 3 | | | |
| | | $0.4 < \Phi$ | | 1 | | | |
| | | TP film scratch | | | | | |
| | | Width(mm) | Length (mm) | Acceptable Qty | | | |
| | | | | A | B | C | |
| | | $\Phi \leq 0.05$ | Ignore | Ignore | | Ignore | |
| | | $0.05 < W \leq 0.06$ | $L \leq 5.0$ | $N \leq 3$ | | | |
| | | $0.07 < W \leq 0.08$ | $L \leq 4.0$ | $N \leq 2$ | | | |
| | | $0.08 < W$ | Define as spot defect | | | | |
| | | Assembly deflection | Beyond the edge of backlight ≤ 0.2 mm | | | | |
| Bulge (undulation included) | The ITO film plumped below 0.40mm is acceptable | | | | | | |
| |  | | | | | | |

| Number | Items | Criteria (mm) | | | | |
|--------|-------------|--|---|------------|-------------------|---|
| 5.0 | RTP Related | Newton Ring | Newton Ring area > 1/3 TP area not acceptable | | |  |
| | | | Newton Ring area ≤ 1/3 TP area acceptable | | | |
| | | TP corner broken X: length Y: Width Z: Height | X | Y | Z |  |
| | | | X ≤ 3.0 mm | Y ≤ 3.0 mm | Z < LCD thickness | |
| | | | Circuitry broken is not allowed | | | |
| | | TP edge broken X: length Y: Width Z: Height | X | Y | Z |  |
| | | | X ≤ 6.0 mm | Y ≤ 2.0 mm | Z < LCD thickness | |
| | | | Circuitry broken is not allowed | | | |

- Criteria (functional items)

| Number | Items | Criteria |
|--------|-----------------------|-------------|
| 1 | No display | Not allowed |
| 2 | Missing segment | Not allowed |
| 3 | Short | Not allowed |
| 4 | Backlight no lighting | Not allowed |
| 5 | TP no function | Not allowed |

6.2 Dealing with Customer Complaints

6.2.1 Non-conforming Analysis

Purchaser should supply Densitron with detailed data of non-conforming sample.

After accepting it, Densitron should complete the analysis in two weeks from receiving the sample. If the analysis cannot be completed on time, Densitron must inform the purchaser.

6.2.2 Handling of Non-conforming Displays

If any non-conforming displays are found during customer acceptance inspection which Densitron is clearly responsible for, return them to Densitron.

Both Densitron and customer should analyse the reason and discuss the handling of non-conforming displays when the reason is not clear.

Equally, both sides should discuss and come to agreement for issues pertaining to modification of Densitron quality assurance standard.

7.0 Reliability Specification

7.1 Reliability Tests

| Test Item | Test Condition | | Sample Size |
|--|---|------|-------------|
| High Temperature Operation | Ta = 85°C | 96 h | 3pcs |
| Low Temperature Operation | Ta = -30°C | 96 h | 3pcs |
| High Temperature Storage | Tp = 90°C | 96 h | 3pcs |
| Low Temperature Storage | Tp = -40°C | 96 h | 3pcs |
| High Temperature & High Humidity Operation | 60°C, 90% RH | 96 h | 3pcs |
| Thermal Shock (Non-operation) | -30°C, 30 min ↔ +85°C, 30 min, Change time: 5min 20CYC. | | 3pcs |
| ESD Test | C=150pF, R=330,5points/panel Air: ±8KV, 5times; Contact: ±6KV, 5 times; (Environment: 15°C~35°C, 30%~60%). | | 3pcs |
| Vibration (Non-operation) | Frequency range: 10~55Hz, Stroke: 1.5mm Sweep: 10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total) (Package condition). | | 3pcs |
| Box Drop Test | 1 Corner 3 Edge 6 faces, 80 cm (Medium Box) | | 1 box |

Note: Ta = ambient temperature, Tp= panel temperature

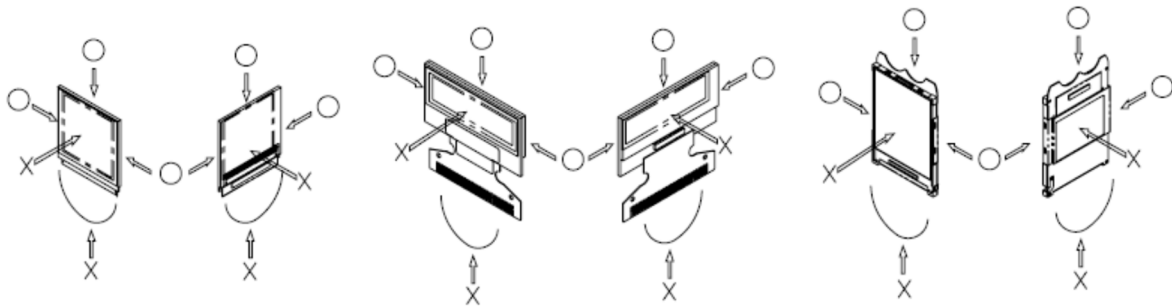
Notes:

1. No dew condensation to be observed.
2. The function test shall be conducted after 4 hours storage at the normal temperature and humidity after removed from the test chamber.
3. No cosmetic or functional defects should be allowed.
4. Total current consumption should be less than twice the initial value.

8.0 Handling Precautions

8.1 Handling Precautions

- 1) Since the display panel is being made of glass, do not apply mechanical impacts such as dropping from a high position.
- 2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- 3) If the liquid crystal touches your skin or clothes, wash it off immediately using soap and plenty of water
- 4) If pressure is applied to the display surface or its neighbourhood of the display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- 5) The polarizer covering the surface of the display module is soft and easily scratched. Please be careful when handling the display module.
- 6) When the surface of the polarizer of the display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
 - a. Scotch Mending Tape No. 810 or an equivalent
2. Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.
3. Also, pay attention that the following liquid and solvent may spoil the polarizer:
 - Water
 - Ketone
 - Aromatic Solvents
- 7) Hold the display module very carefully when placing it into the system housing. Do not apply excessive stress or pressure to display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- 8) Do not apply stress to the LSI chips and the surrounding molded sections.
- 9) Do not disassemble nor modify the display module.
- 10) Do not apply input signals while the logic power is off.
- 11) Pay sufficient attention to the working environments when handing display modules to prevent occurrence of element breakage accidents by static electricity.
 - Be sure to make human body grounding when handling display modules.
 - Be sure to ground tools to use or assembly such as soldering irons.
 - To suppress generation of static electricity, avoid carrying out assembly work under dry environments.

- Protective film is being applied to the surface of the display panel of the display module. Be careful since static electricity may be generated when exfoliating the protective film.
- 12) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. If the display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).
 - 13) If electric current is applied when the display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

8.2 Storage Precautions

- 1) When storing display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps, etc. and, also, avoiding high temperature and high humidity environments or low temperature (less than 0°C) environments. (We recommend you to store these modules in the packaged state when they were shipped from Densitron) At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.
- 2) If electric current is applied when water drops are adhering to the surface of the display module, when the display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

8.3 Designing Precautions

- 1) The absolute maximum ratings are the ratings which cannot be exceeded for display module, and if these values are exceeded, panel damage may be happen.
- 2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- 3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- 4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighbouring devices.
- 5) As for EMI, take necessary measures on the equipment side basically.
- 6) When fastening the display module, fasten the external plastic housing section.
- 7) If power supply to the display module is forcibly shut down by such errors as taking out the main battery while the display panel is in operation, we cannot guarantee the quality of this display module.

8.4 Operation Precautions

- 1) It is indispensable to drive the display within the specified voltage limit since excessive voltage shortens its life.
- 2) Direct current causes an electrochemical reaction with remarkable deterioration of the display quality. Consider prevent direct current during ON/OFF timing and during operation.
- 3) Response time is extremely delayed at temperatures lower than the operating temperature range while, at high temperatures, displays become dark. However, this phenomenon is reversible and does not mean a malfunction or a display that has been permanently damaged.
- 4) To protect display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the display modules.
 - Pins and electrodes
 - Pattern layouts such as the FPC
- 5) When the driver is being exposed (COG), semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if the driver is exposed to light, malfunctioning may occur.
 - Design the product and installation method so that the driver may be shielded from light in actual usage.
 - Design the product and installation method so that the driver may be shielded from light during the inspection processes.
- 6) Although the display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- 7) We recommend you construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.

8.5 Other Precautions

Request the qualified companies to handle industrial wastes when disposing of the display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.